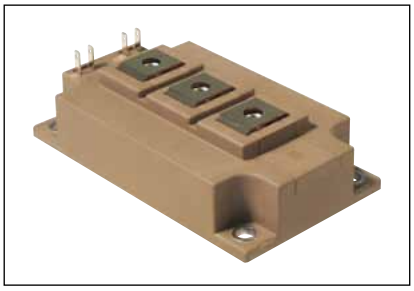
2MBI300VD-120-50

IGBT Modules

IGBT MODULE (V series)
1200V / 300A / 2 in one package



Features
High speed switching
Voltage drive
Low Inductance module structure

Applications
Inverter for Motor Drive
AC and DC Servo Drive Amplifier
Uninterruptible Power Supply
Industrial machines, such as Welding machines

Maximum Ratings and Characteristics

● **Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)**

Items		Symbols	Conditions		Maximum ratings	Units
Inverter	Collector-Emitter voltage	V_{CES}			1200	V
	Gate-Emitter voltage	V_{GES}			±20	V
	Collector current	Ic	Continuous	Tc=100°C	300	
				Tc=25°C	360	
		Ic pulse	1ms		600	
		-Ic			300	
		-Ic pulse	1ms		600	
	Collector power dissipation	Pc	1 device		2205	W
Junction temperature		Tj			175	°C
Operating junction temperature (under switching conditions)		T_{jop}			150	
Case temperature		T_C			125	
Storage temperature		Tstg			-40 ~ +125	
Isolation voltage	between terminal and copper base (*1)	V_{iso}	AC : 1min.		2500	VAC
Screw torque	Mounting (*2)	-			6.0	N m
	Terminals (*3)				5.0	

Note *1: All terminals should be connected together during the test.
Note *2: Recommendable Value : 3.0-6.0 Nm (M5 or M6)
Note *3: Recommendable Value : 2.5-5.0 Nm (M6)

● **Electrical characteristics (at Tj= 25°C unless otherwise specified)**

Items		Symbols	Conditions		Characteristics min.	Characteristics typ.	Characteristics max.	Units
Inverter	Zero gate voltage collector current	I_{CES}	V_{GE} = 0V, V_{CE} = 1200V		-	-	2.0	mA
	Gate-Emitter leakage current	I_{GES}	V_{CE} = 0V, V_{GE} = ±20V		-	-	400	nA
	Gate-Emitter threshold voltage	$V_{GE(th)}$	V_{CE} = 20V, I_C = 300mA		6.0	6.5	7.0	V
	Collector-Emitter saturation voltage	$V_{CE(sat)}$ (terminal)	V_{GE} = 15V, I_C = 300A	Tj=25°C	-	2.00	2.45	V
				Tj=125°C	-	2.35	-	
				Tj=150°C	-	2.40	-	
		$V_{CE(sat)}$ (chip)		Tj=25°C	-	1.85	2.10	
				Tj=125°C	-	2.15	-	
				Tj=150°C	-	2.20	-	
	Internal gate resistance	$R_{g(int)}$	-		-	2.5	-	Ω
	Input capacitance	Cies	V_{CE} = 10V, V_{GE} = 0V, f = 1MHz		-	24.0	-	nF
	Turn-on time	ton	V_{CC} = 600V, I_C = 300A, V_{GE} = ±15V, R_G = 1.8Ω, Tj = 150°C, Ls =30nH		-	0.60	-	μsec
		tr			-	0.20	-	
		tr (i)			-	0.05	-	
	Turn-off time	toff			-	0.80	-	
		tf			-	0.08	-	
	Forward on voltage	V_F (terminal)	V_{GE} = 0V, I_F = 300A	Tj=25°C	-	1.85	2.25	V
				Tj=125°C	-	2.00	-	
				Tj=150°C	-	1.95	-	
		V_F (chip)		Tj=25°C	-	1.70	1.95	
				Tj=125°C	-	1.85	-	
				Tj=150°C	-	1.80	-	
	Reverse recovery time	trr	I_F = 300A		-	0.15	-	μsec

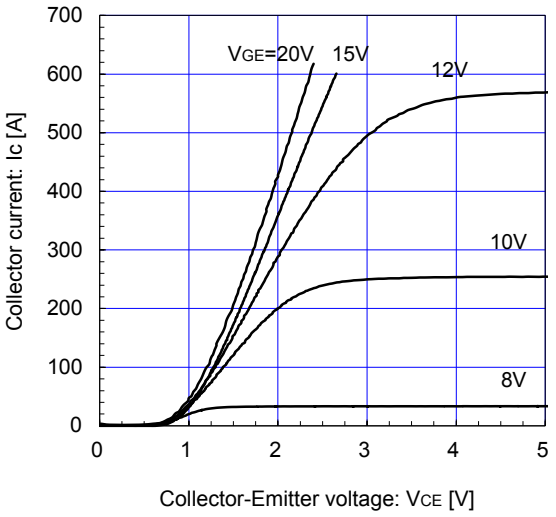
● **Thermal resistance characteristics**

Items	Symbols	Conditions	Characteristics min.	Characteristics typ.	Characteristics max.	Units
Thermal resistance (1device)	Rth(j-c)	IGBT	-	-	0.068	°C/W
		FWD	-	-	0.110	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.0125	-	

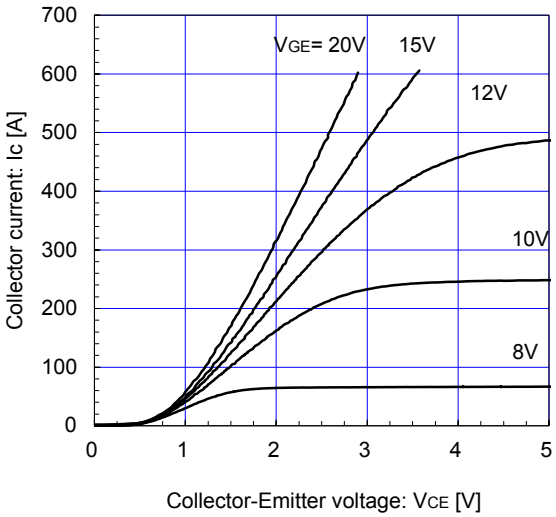
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

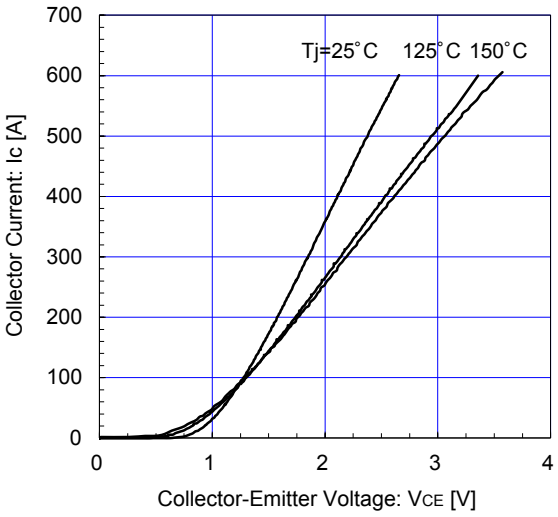
Collector current vs. Collector-Emitter voltage (typ.)
Tj= 25°C / chip



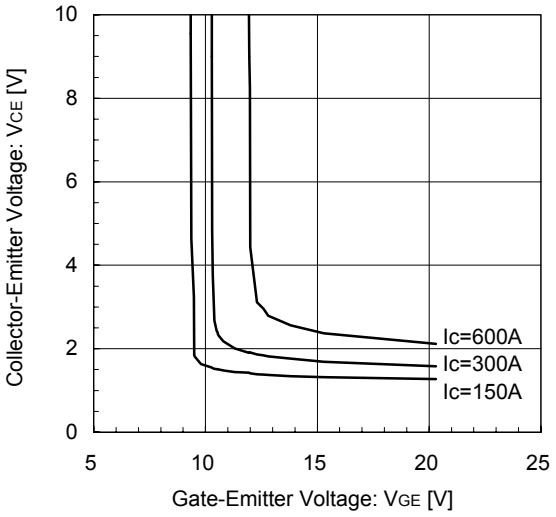
Collector current vs. Collector-Emitter voltage (typ.)
Tj= 150°C / chip



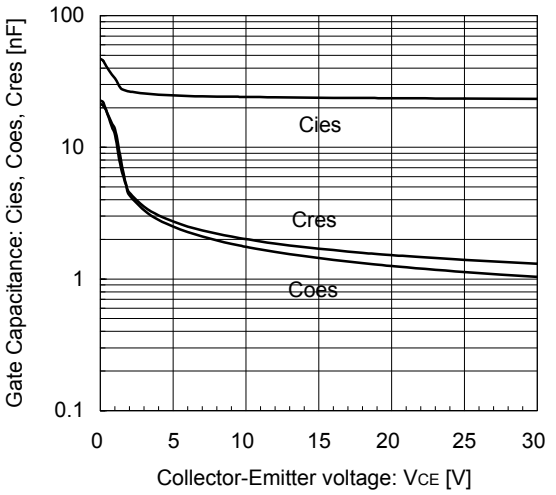
Collector current vs. Collector-Emitter voltage (typ.)
VGE= 15V / chip



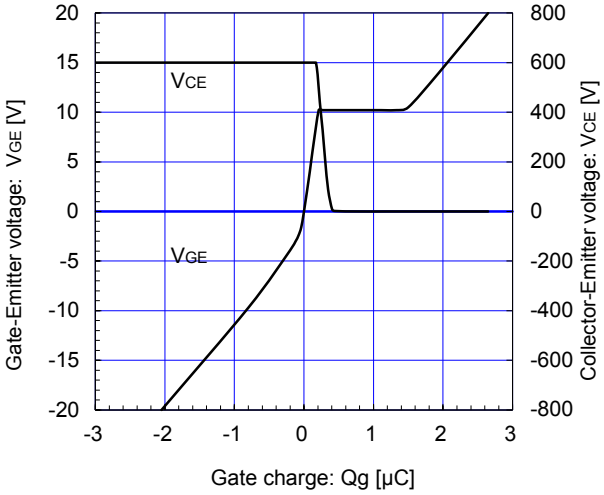
Collector-Emitter voltage vs. Gate-Emitter voltage
Tj= 25°C / chip



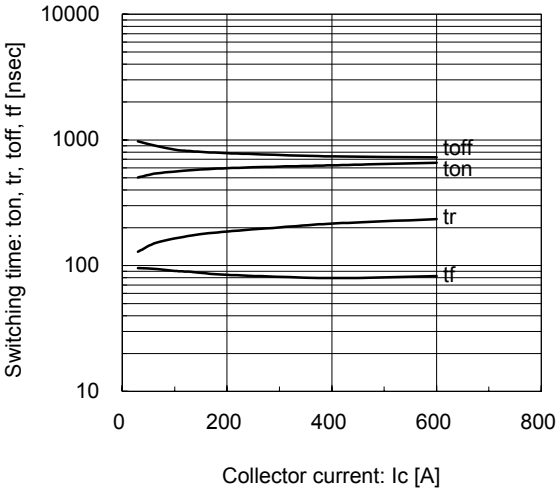
Gate Capacitance vs. Collector-Emitter Voltage
VGE= 0V, *f*= 1MHz, Tj= 25°C



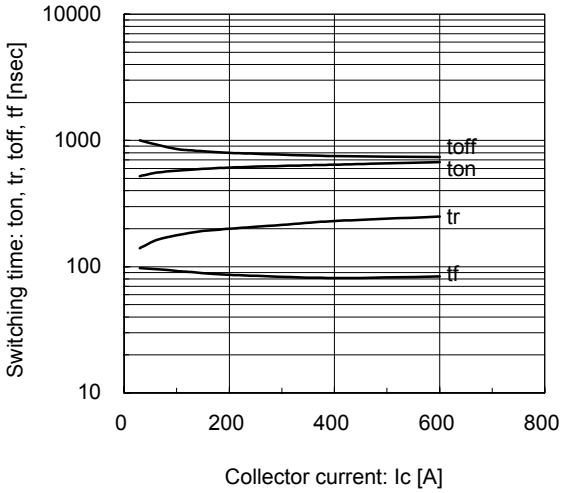
Dynamic Gate Charge (typ.)
Vcc=600V, Ic=300A, Tj= 25°C



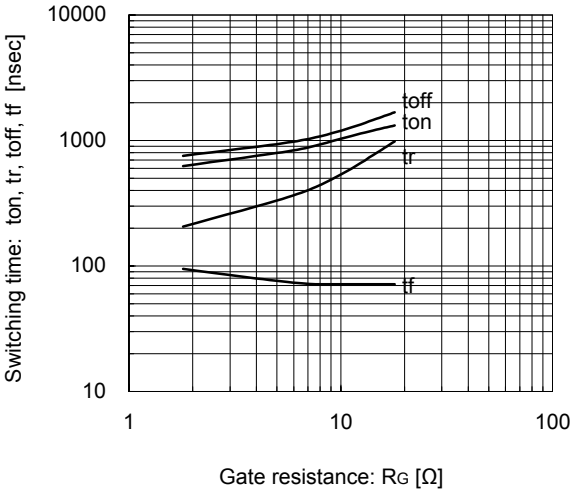
Switching time vs. Collector current (typ.)
Vcc=600V, VGE=±15V, RG=1.8Ω, Tj=125°C



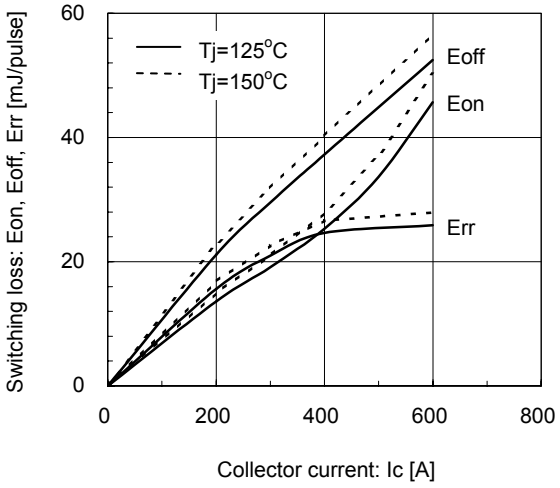
Switching time vs. Collector current (typ.)
Vcc=600V, VGE=±15V, RG=1.8Ω, Tj=150°C



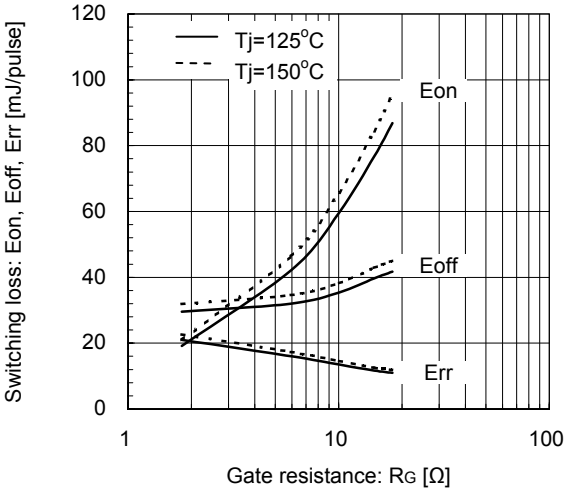
Switching time vs. Gate resistance (typ.)
Vcc=600V, Ic=300A, VGE=±15V, Tj=125°C



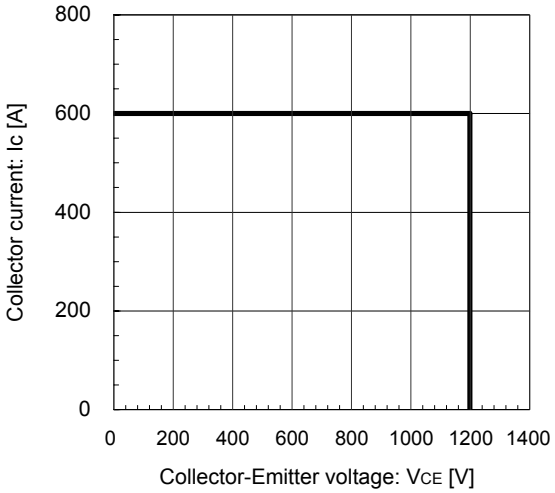
Switching loss vs. Collector current (typ.)
Vcc=600V, VGE=±15V, RG=1.8Ω, Tj=125, 150°C



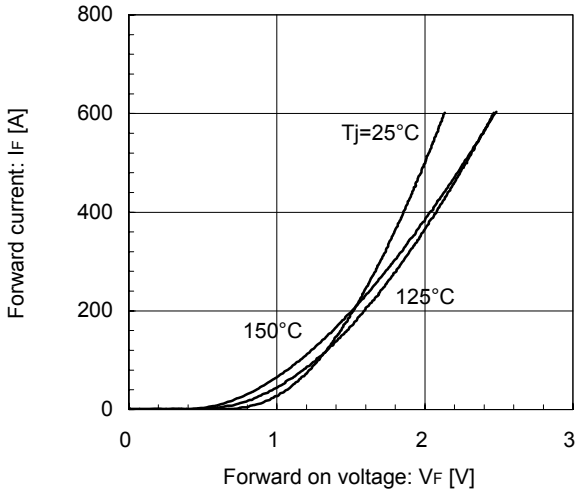
Switching loss vs. Gate resistance (typ.)
Vcc=600V, Ic=300A, VGE=±15V, Tj=125, 150°C



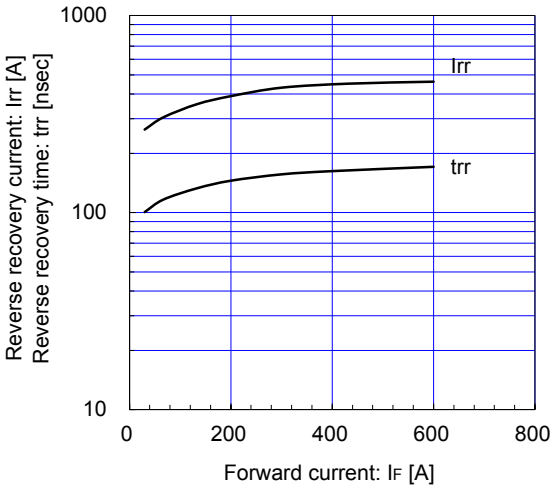
Reverse bias safe operating area (max.)
+VGE=15V, -VGE=15V, RG=1.8Ω, Tj=150°C



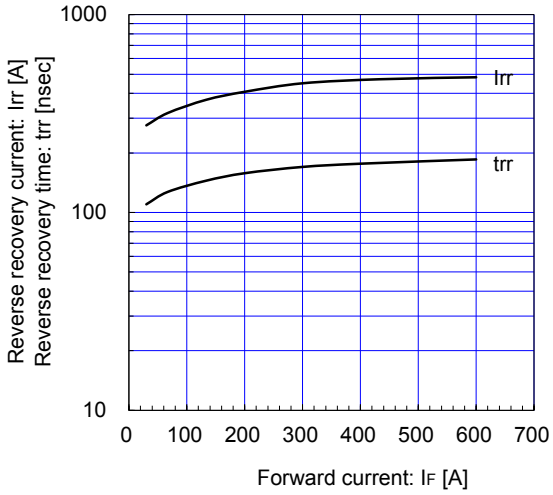
Forward Current vs. Forward Voltage (typ.)
chip



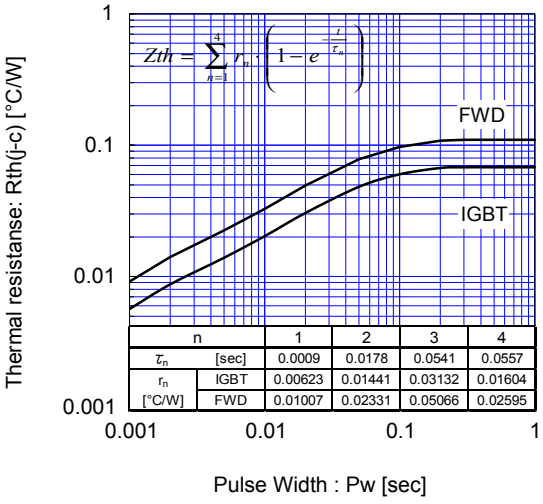
Reverse Recovery Characteristics (typ.)
Vcc=600V, VGE=±15V, RG=1.8Ω, Tj=125°C



Reverse Recovery Characteristics (typ.)
Vcc=600V, VGE=±15V, RG=1.8Ω, Tj=150°C

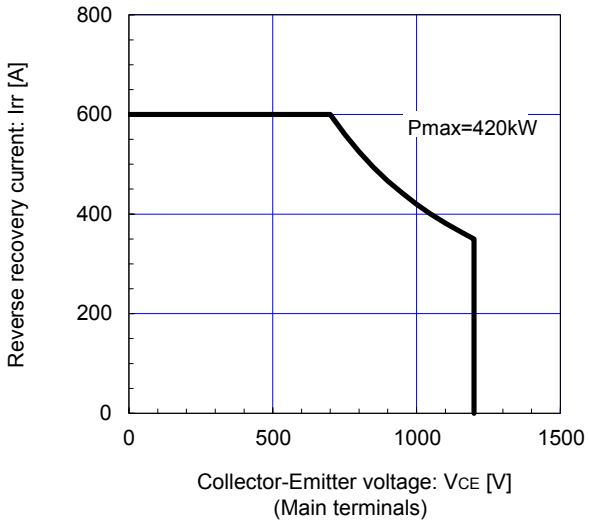


Transient Thermal Resistance (max.)

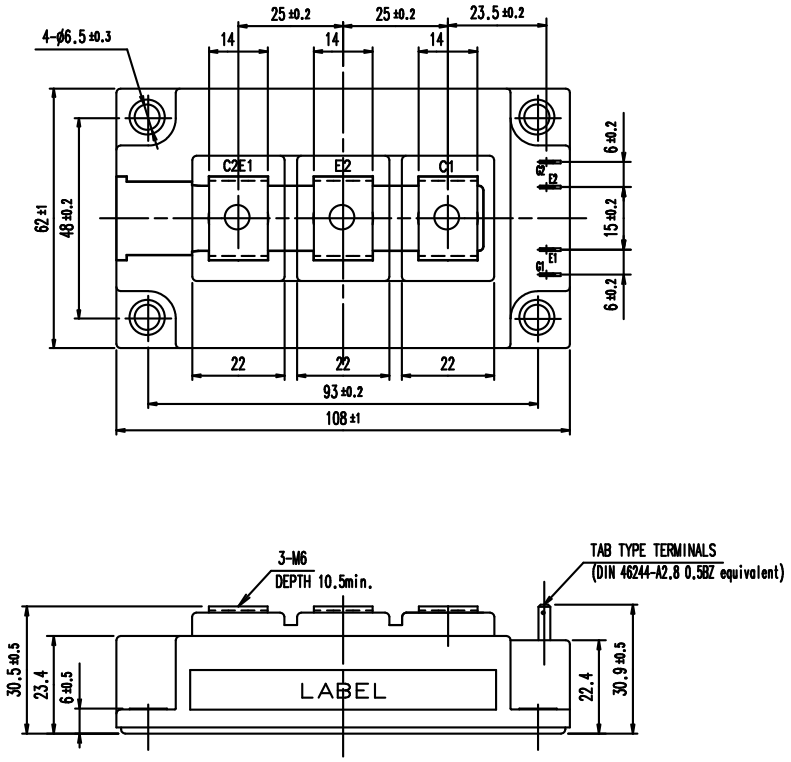


n		1	2	3	4
τ_n	[sec]	0.0009	0.0178	0.0541	0.0557
r_n [°C/W]	IGBT	0.00623	0.01441	0.03132	0.01604
	FWD	0.01007	0.02331	0.05066	0.02595

FWD safe operating area (max.)
Tj=150°C

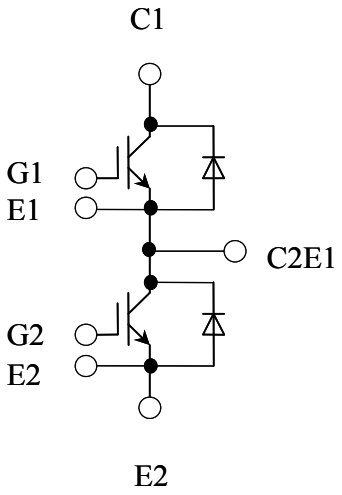


■ Outline Drawings (Unit: mm)



Weight: 370g (typ.)

■ Equivalent Circuit



WARNING

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- Communications equipment (terminal devices)
- Measurement equipment
- Machine tools
- Audiovisual equipment
- Electrical home appliances
- Personal equipment
- Industrial robots etc.

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- Emergency equipment for responding to disasters and anti-burglary devices
- Safety devices
- Medical equipment

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